

UNISONIC TECHNOLOGIES CO., LTD

# 4N65-TA5

Preliminary

# 4.0A, 650V N-CHANNEL POWER MOSFET

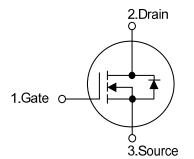
## DESCRIPTION

The UTC **4N65-TA5** is a high voltage and high current power MOSFET , designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

### FEATURES

- \*  $R_{DS(ON)}$  < 2.8 $\Omega$  @  $V_{GS}$  = 10 V,  $I_D$  = 2.0A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

#### SYMBOL

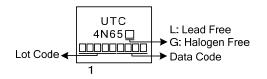


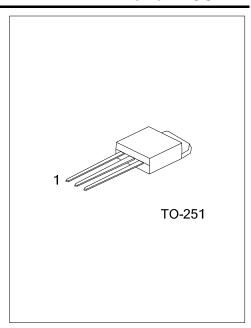
ORDERING INFORMATION

Ordering Number			Deekege	Pin Assignment			Packing		
	Lead Free	Haloge	en Free	- Package	1	2	3	Facking	
	4N65L-TM3-T 4N65G-TM3-T		TO-251	G	D	S	Tube		
Note:	Note: Pin Assignment: G: Gate D: Drain S: Source								

4N65L-TM3-T	
(1)Packing Type	(1) T: Tube
(2)Package Type	(2) TM3: TO-251
(3)Green Package	(3) L: Lead Free, G: Halogen Free and Lead Free

#### MARKING





#### ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETE	ER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	650	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Avalanche Current (Note 2)		I <sub>AR</sub>	4.0	А
Continuous Drain Current		I <sub>D</sub>	4.0	А
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	12	А
Avalanche Energy S	Single Pulsed (Note 3)	E <sub>AS</sub>	67	mJ
Peak Diode Recovery dv/dt (No	ote 4)	dv/dt	1.56	V/ns
Power Dissipation (T <sub>C</sub> =25°C)		PD	50	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T <sub>OPR</sub>	-55 ~ +150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	С°

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by T<sub>J</sub>.

3. L=15mH, I<sub>AS</sub>=3.0A, V<sub>DD</sub>=50V, R<sub>G</sub>=25  $\Omega$ , Starting T<sub>J</sub> = 25°C

4. I<sub>SD</sub>≤4.0A, di/dt ≤100A/µs, V<sub>DD</sub>≤BV<sub>DSS</sub>, Starting  $T_J$  = 25°C

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ <sub>JA</sub>	110	°C/W	
Junction to Case	θ <sub>JC</sub>	2.5	°C/W	



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#### ■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub> =25°C, unless otherwise specified)

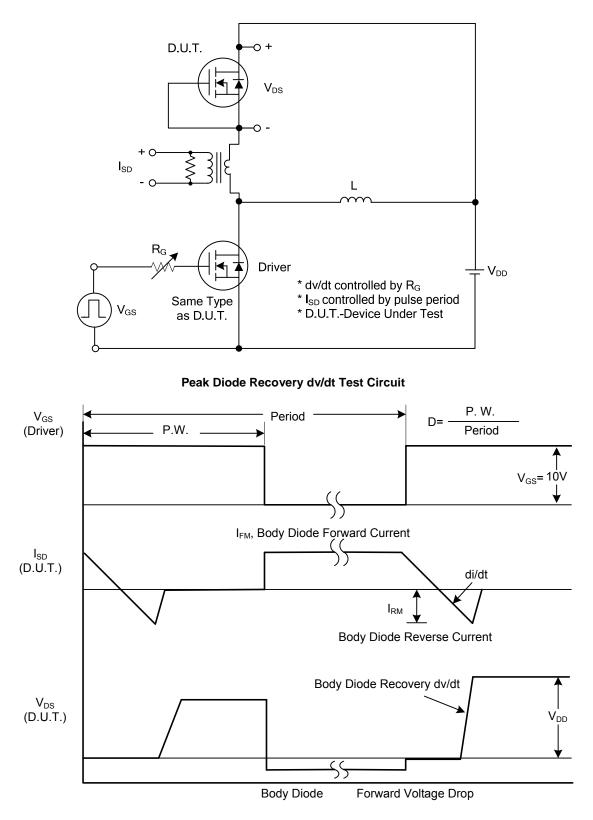
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS				1					
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	650			V		
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μA		
Posta Davina Laskana Dumant F	orward	1	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA		
Gate-Source Leakage Current	leverse	I <sub>GSS</sub>	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0	V		
Static Drain-Source On-State Resis	tance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.0A			2.8	Ω		
DYNAMIC CHARACTERISTICS						_			
Input Capacitance		CISS			520		рF		
Output Capacitance		Coss	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1MHz		52		pF		
Reverse Transfer Capacitance		C <sub>RSS</sub>			6		рF		
SWITCHING CHARACTERISTICS									
Total Gate Charge		$Q_{G}$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A , I <sub>G</sub> =100µA (Note 1, 2)		33		nC		
Gate-Source Charge		$Q_{GS}$			4.5		nC		
Gate-Drain Charge		$Q_{GD}$	$I_{G}$ = 100 $\mu$ A (Note 1, 2)		4.8		nC		
Turn-On Delay Time		t <sub>D(ON)</sub>			48		ns		
Turn-On Rise Time		t <sub>R</sub>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A,		30		ns		
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		120		ns		
Turn-Off Fall Time		t⊨			30		ns		
SOURCE- DRAIN DIODE RATING	S AND C	HARACTER	ISTICS	<u>.</u>					
Maximum Continuous Drain-Source Diode		I <sub>S</sub>				4.0	А		
Forward Current						4.0	A		
Maximum Pulsed Drain-Source Diode		I <sub>SM</sub>				12	А		
Forward Current						12	~		
Drain-Source Diode Forward Voltag	e	$V_{SD}$	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 4.0 A			1.4	V		
Reverse Recovery Time		t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =4.0A		400		ns		
Reverse Recovery Charge			dl <sub>F</sub> /dt=100A/µs (Note 1)		2.13		μC		
Notae: 1 Pulse Test: Pulse width <	300ue F	$t_{\rm v}$	V <sub>a</sub>						

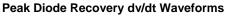
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle $\leq$ 2%.

2. Essentially independent of operating temperature.



## TEST CIRCUITS AND WAVEFORMS





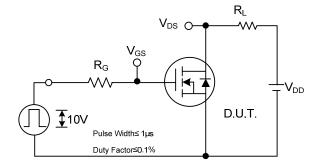


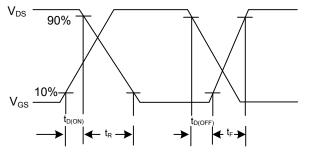
 $\mathsf{V}_{\mathsf{GS}}$ 

10V

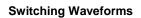
 $Q_{GS}$ 

## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



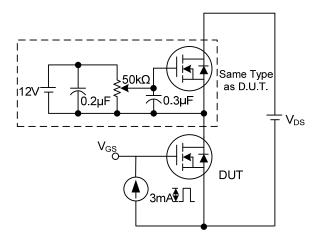


#### Switching Test Circuit

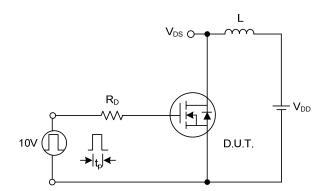


 $\mathsf{Q}_\mathsf{G}$ 

 $Q_{GD}$ 



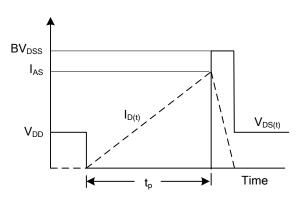
Gate Charge Test Circuit



**Unclamped Inductive Switching Test Circuit** 

**Gate Charge Waveform** 

Charge



**Unclamped Inductive Switching Waveforms** 



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